

PNP SILICON EPITAXIAL TRANSISTOR
FOR HIGH-SPEED SWITCHING

The 2SB1669 is a power transistor that can be directly driven from the output of an IC. This transistor is ideal for OA and FA equipment such as motor and solenoid drivers.

FEATURES

- High DC current amplifier rate
 $h_{FE} \geq 100$ ($V_{CE} = -5.0$ V, $I_C = -0.5$ A)
- Z type available for surface mounting supported products

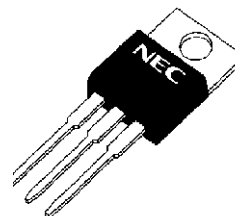
ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	Ratings	Unit
Collector to base voltage	V_{CBO}		-60	V
Collector to emitter voltage	V_{CEO}		-60	V
Emitter to base voltage	V_{EBO}		-7.0	V
Collector current (DC)	$I_{C(DC)}$		-3.0	A
Collector current (pulse)	$I_{C(pulse)}$	$PW \leq 10$ ms, duty cycle $\leq 50\%$	-6.0	A
Base current (DC)	$I_{B(DC)}$		-1.0	A
Total power dissipation	P_T	($T_C = 25^\circ\text{C}$)	25	W
		($T_A = 25^\circ\text{C}$)	1.5	W
Junction temperature	T_j		150	$^\circ\text{C}$
Storage temperature	T_{stg}		-55 to +150	$^\circ\text{C}$

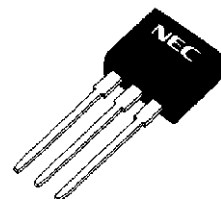
ORDERING INFORMATION

Part No.	Package
2SB1669	TO-220AB
2SB1669-S	TO-262
2SB1669-Z	TO-220SMD

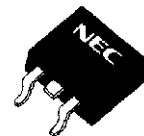
(TO-220AB)



(TO-262)



(TO-220SMD)



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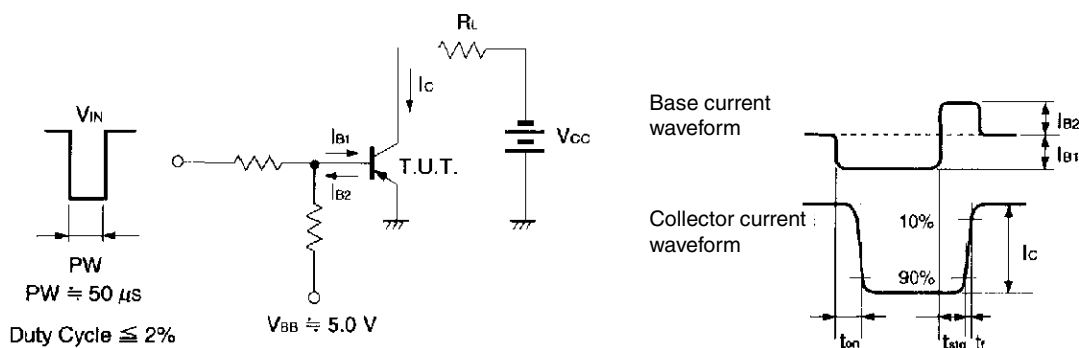
Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

ELECTRICAL CHARACTERISTICS (T_A = 25°C)

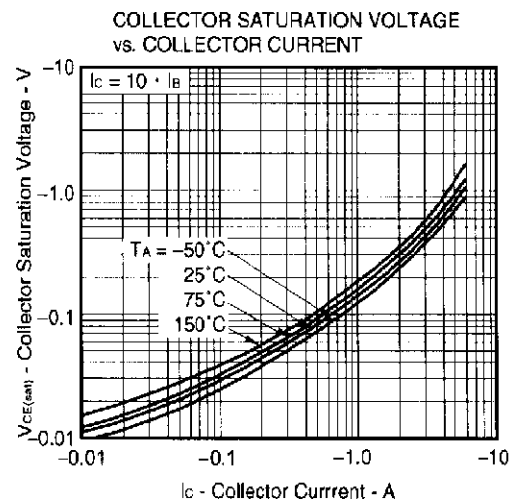
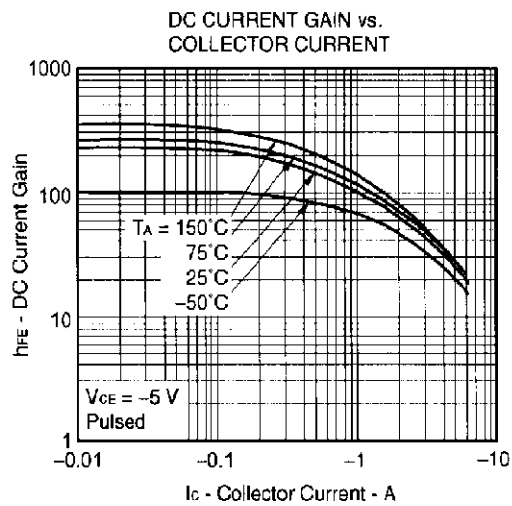
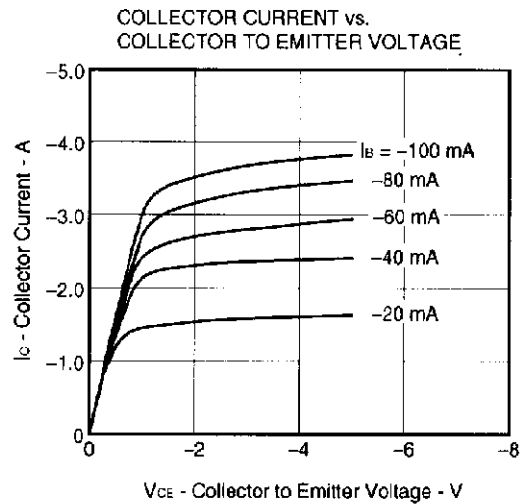
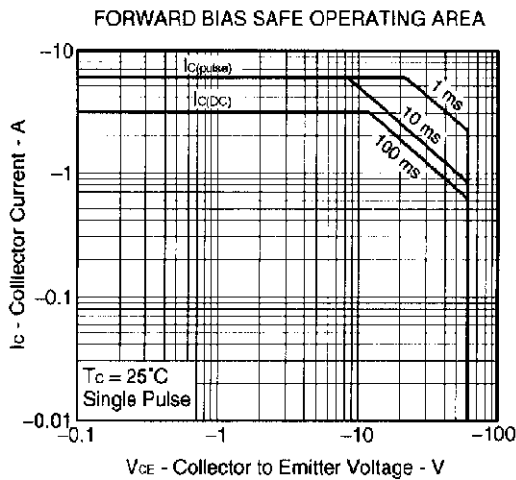
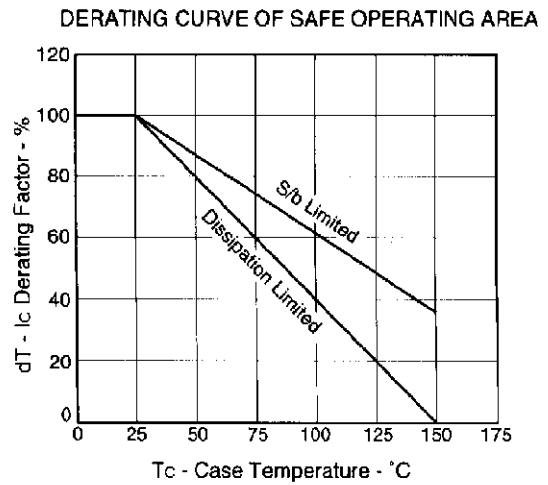
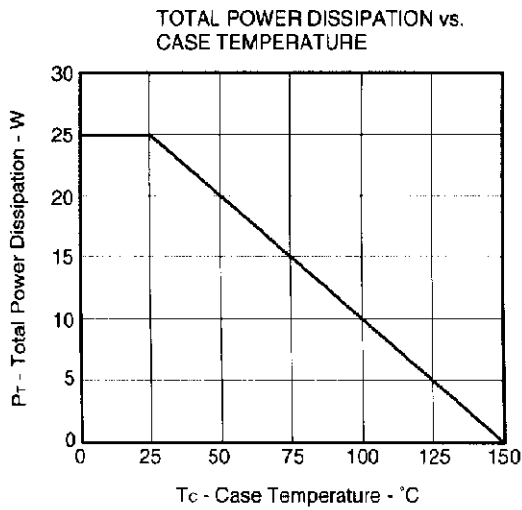
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	I _{CBO}	V _{CB} = -60 V, I _E = 0 A			-10	μA
DC current gain	h _{FE1}	V _{CE} = -5.0 V, I _C = -0.5 A ^{Note}	100		400	-
	h _{FE2}	V _{CE} = -5 V, I _C = -3 A ^{Note}	20			-
Collector saturation voltage	V _{CE(sat)}	I _C = -3.0 A, I _B = -300 mA ^{Note}			-1.0	V
Base saturation voltage	V _{BE(sat)}	I _C = -3.0 A, I _B = -300 mA ^{Note}			-2.0	V
Gain bandwidth product	f _T	V _{CE} = -5.0 V, I _C = -0.5 A		5		MHz
Collector capacitance	C _{ob}	V _{CB} = -10 V, I _E = 0 A, f = 10 MHz		80		pF
Turn-on time	t _{on}	I _C = -2.0 A, R _L = 15 Ω, I _{B1} = -I _{B2} = -200 mA, V _{CC} ≅ -30 V Refer to the test circuit.		0.4		μs
Storage time	t _{stg}			1.7		μs
Fall time	t _f			0.5		μs

Note Pulse test PW ≤ 350 μs, duty cycle ≤ 2%

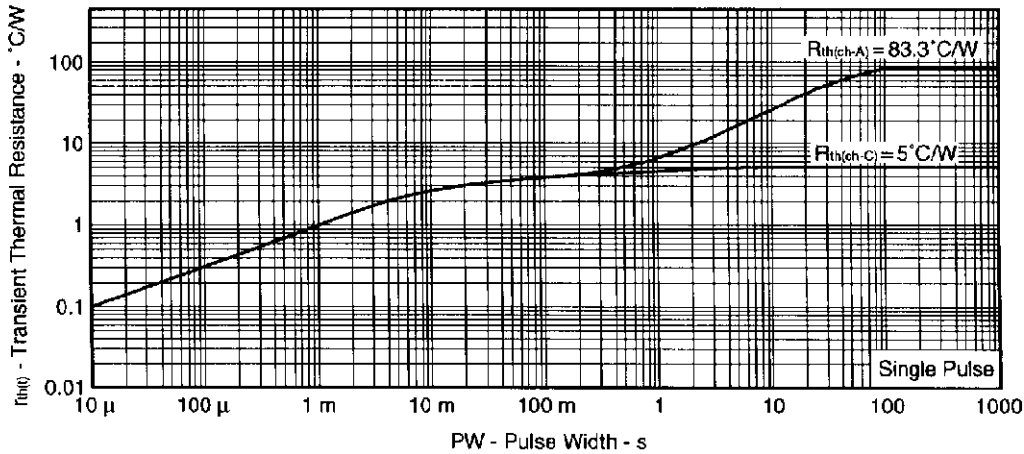
SWITCHING TIME (t_{on}, t_{stg}, t_f) TEST CIRCUIT



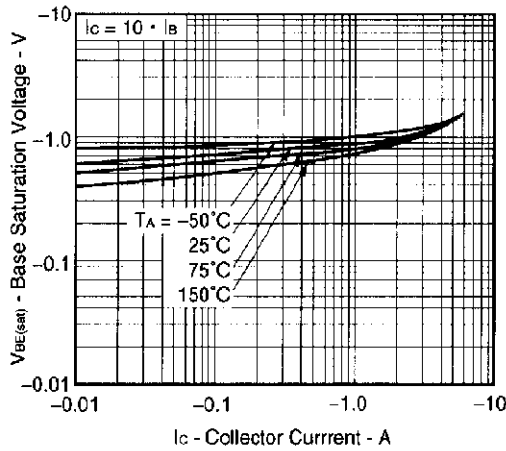
TYPICAL CHARACTERISTICS (T_A = 25°C)



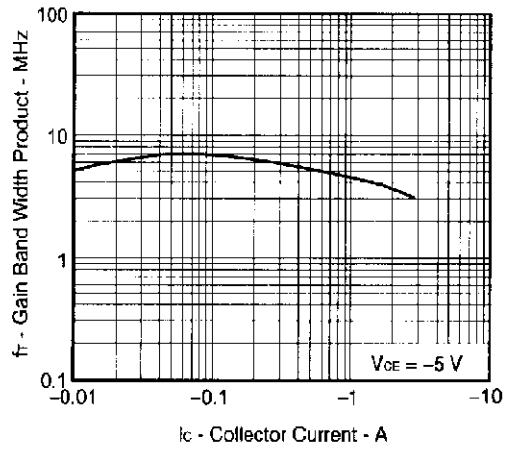
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



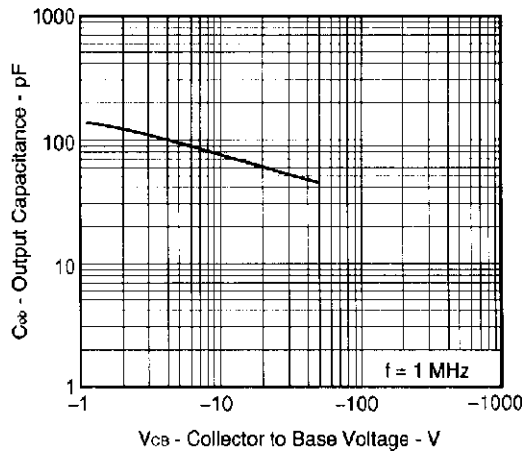
BASE SATURATION VOLTAGE vs. COLLECTOR CURRENT



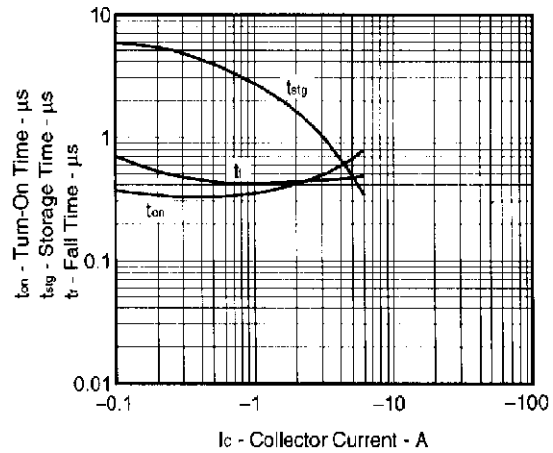
GAIN BAND WIDTH PRODUCT vs. COLLECTOR CURRENT



OUTPUT CAPACITANCE vs. COLLECTOR TO BASE VOLTAGE

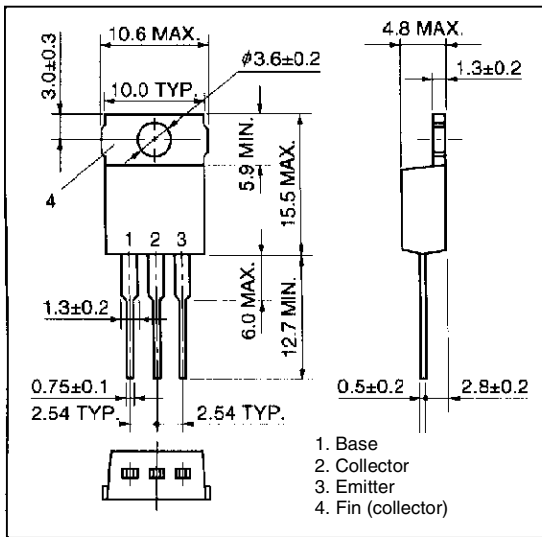


SWITCHING CHARACTERISTICS

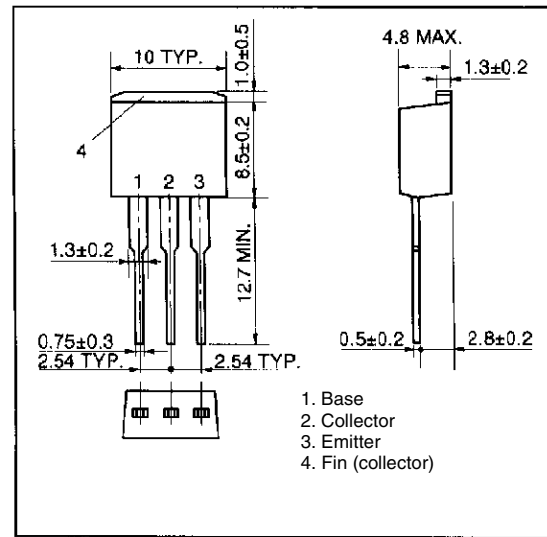


PACKAGE DRAWING (UNIT: mm)

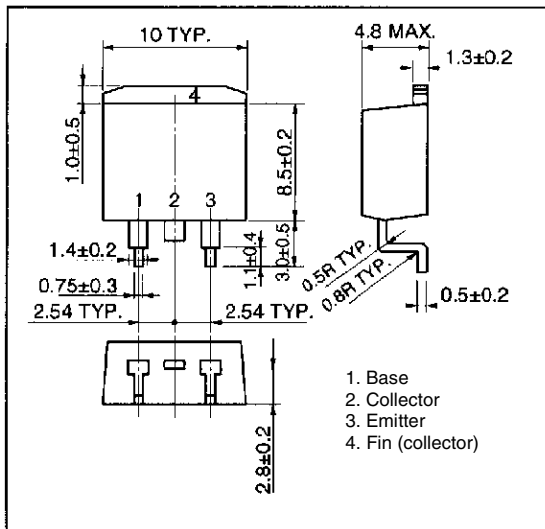
1) TO-220AB (MP-25)



2) TO-262 (MP-25 Fin Cut)



3) TO-220SMD (MP-25Z)



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